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(54) Title: MULTI-DRIVER TOUCH PANEL

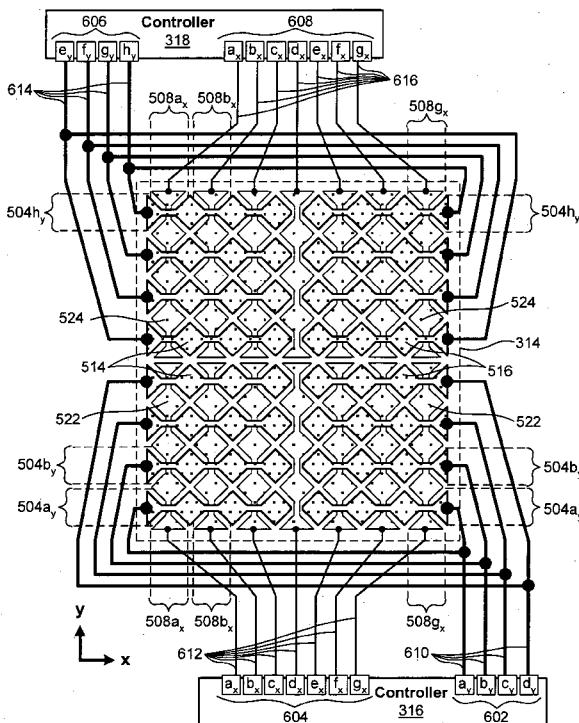


FIG. 6

(57) **Abstract:** A novel capacitive touch system includes a first controller having a plurality of channels, a first sensor row having a first discrete sensor element and a second discrete sensor element, a second sensor row having a first discrete sensor element and a second discrete sensor element, a first sensor column, a second sensor column, and a first signal line electrically coupling one of the plurality of channels of the controller to both the first and second discrete sensor elements of the first sensor row. In a particular embodiment, the capacitive touch system includes a second controller having a plurality of channels, the first sensor column includes a first discrete sensor element and a second discrete sensor element, and a first channel of the second controller is electrically coupled to both the first and second discrete sensor elements of the first sensor column.



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MULTI-DRIVER TOUCH PANEL

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RELATED APPLICATIONS

10 This application claims the benefit of priority to co-pending U.S. Provisional Patent Application Serial No. 61/285,849, filed December 11, 2009 by the same inventors and entitled "Multi-Driver Touch Panel," which is incorporated by reference herein in its entirety.

15 BACKGROUND OF THE INVENTION

Field of the Invention

This invention relates generally to touchscreen devices, and more particularly to capacitive touch systems.

20 Description of the Background Art

Currently, touchscreens are being used in embedded systems such as Smartphones, MP3 players, tablet computers, navigation systems, automatic teller machines (ATMs), and others. Traditionally, touchscreens were extremely expensive to manufacture and, therefore, impractical for most applications. However, more cost effective manufacturing processes have since been developed and touchscreen technology is rapidly gaining popularity in the electronics industry. Indeed, many conventional human-computer interface (HCI) input devices (e.g., keypads/keyboards, mechanical buttons, dials, etc.) are being replaced with touchscreens. Therefore, it is expected that the use of touchscreens in embedded applications will continue to increase for the foreseeable future.

25 30 A touchscreen system typically includes a transparent touch-sensor panel used in conjunction with an underlying graphical display device (e.g., liquid crystal display). The touch-sensor panel receives user inputs by detecting the location of a target object such as, for example, a finger, stylus, etc. The display device projects graphical output images directly

through the touch-sensor panel such that human-computer interaction takes place at the touch surface of the touch-sensor panel.

One type of touch-sensor panel, the resistive touch panel, is used in many electronic devices today. A resistive touch panel is composed of two conductive layers, one of which deforms under pressure when it is touched by a target object. When the deformable conductive layer contacts the underlying conductive layer, a change in resistance between the layers is generated. A controller uses this change in resistance to determine the location of the touch.

Although resistive touch panels are still widely used, the overall design has several problems. For example, the deformable conductive layer has to be constructed from an extremely soft material in order to flex under low pressure. Consequently, the deformable layer can be punctured very easily, or damaged by abrasive or caustic cleaners. Moreover, the deformable layer can eventually fatigue over time and become "stretched" resulting in loss of touch sensitivity. As another example, resistive touch panels typically have poor optical quality because of the relatively low transparency of the materials from which most deformable layers are made. Another contributing factor to the poor optical quality is that the deformable layer tends to disperse light when deformed thereby causing the underlying display image to appear temporarily distorted.

The aforementioned problems associated with resistive touch panels are inherent to their fundamental design and operation. As a result, manufacturers and designers have been migrating away from resistive touch panels and toward the development of capacitive touch-sensor panels. The main advantage to capacitive touch-sensor panels is that they are not mechanically actuated. Instead, they locate target objects by sensing the presence of their electrical charge. Indeed, a target object need not necessarily make contact with the capacitive touch-sensor panel in order to be detected. This effectively eliminates the need for any flexible or moving parts. Accordingly, the touch surface of a capacitive touch-sensor panel is typically defined by a rigid transparent plate (i.e. glass), which has a much higher transparency and, therefore, optical quality than that of flexible touch surfaces. Furthermore, a glass touch surface does not deform and is, therefore, not susceptible to fatigue over time.

A capacitive touch system typically includes a capacitive sensor panel and a sensor controller. The sensor panel is a multi-layer composite structure composed of a first glass plate having a bottom surface whereon a first conductive layer is formed and a second glass plate having a bottom surface whereon a second conductive layer is formed. The first and second glass plates are typically affixed in a stacked relationship such that the first conductive

layer is disposed between the bottom surface of the first plate and the top surface of the second plate. Further, the sensor panel is affixed directly over the screen of a display device (e.g., LCD) such that the second conductive layer is disposed between the bottom surface of the second glass plate and the top surface of the display screen. The conductive layers are 5 typically composed of a transparent conductive material such as, for example, indium tin oxide (ITO) that is deposited by some suitable means (e.g., sputter deposition) and etched in specific patterns. That is, the first conductive layer typically defines a plurality of sensor rows arranged along a y-direction and the second conductive layer typically defines a plurality of sensor columns arranged along an x-direction. Accordingly, the sensor rows and 10 sensor columns, together, define a two-dimensional xy sensor area. The sensor controller is, for example, an microcontroller chip that is electrically coupled to each of the sensor rows and columns so as to monitor their capacitive state. Further, the sensor controller is also electrically coupled to the host device so as to facilitate communication therebetween.

FIG. 1 illustrates the circuitry of a prior art capacitive touch system 100 including a 15 sensor panel 102 and a sensor controller 104. Sensor panel 102 includes a plurality of sensor rows 106ay-fy and a plurality of sensor columns 108ax-fx juxtaposed along the y and x directions, respectively. Each of sensor rows 106ay-fy includes a discrete sensor element 110 and each of sensor columns 108ax-fx includes a discrete sensor element 112. Each sensor element 110 and 112 is a thin pattern of ITO that defines a series of connected diamond 20 shapes extending completely across the touch surface of sensor panel 102 in the x and y directions, respectively. Sensor controller 104 includes a first set of channels 114ay-fy and a second set of channels 116ax-fx. Each of channels 114ay-fy is electrically connected to the sensor element 110 of each respective one of sensor rows 106ay-fy via one of a set of signal lines 118 (e.g., conductive traces, wires, etc.). Likewise, each of channels 116ax-fx is 25 electrically connected to the sensor element 112 of each respective one of sensor columns 108ax-fx via one of a set of signal lines 120. During the operation of touch system 100, controller 104 continuously repeats a cycle of sequentially scanning sensor rows 106ay-fy and columns 108ax-fx so as to measure the capacitive states of their respective sensor elements 110 and 112. There are many known methods for measuring the capacitive state of a sensor 30 element such as, for example, charging the element and observing the settling time. The sample measurement is then compared to a stored value indicative of the elements normal capacitive state in the absence of a target object. When a target object approaches a particular area of sensor panel 102, the natural charge of the target object causes the capacitive state of nearby sensor elements 110 and 112 to change. Algorithms then process the capacitive

change in nearby sensor elements 110 and 112 to generate y and x coordinates indicative of the touch location. Controller 104 then provides these coordinates to the hosting device where they undergo further processing for mapping the coordinates to the underlying graphical display device.

5 Although prior art capacitive touch system 100 has advantages over resistive touch systems, several problems still exist. For example, ITO has a relatively high resistance which imposes constraints on the length of sensor elements 110 and 112. Generally, as the series resistance of a capacitive sensor element increases, the touch sensitivity decreases. Because series resistance increases proportionally with the length of an element, sensor elements 110 and 112 have to be relatively short in order to achieve an acceptable degree of sensitivity.

10 Consequently, the design of touch system 100 is not suitable for use in applications employing large display screens. Although the series resistance can be reduced by increasing the area of the diamond pattern, doing so reduces the sensor resolution of a sensor panel. Also, the series resistance can be reduced by using a low surface resistance ITO layer, but

15 15 doing so reduces the transparency of the of the sensor elements and makes the sensor elements visible.

FIG. 2 illustrates a prior art capacitive touch system 200 that addresses the size and resolution constraints imposed by the high resistance of ITO. System 200 includes a sensor panel 202, a first sensor controller 204, and a second sensor controller 206. Sensor panel 202 includes a plurality of sensor rows 208ay-hy extending in the x-direction. Sensor panel 202 further includes and a plurality of sensor columns 210ax-gx extending in the y-direction. Each of sensor rows 208ay-hy includes a respective discrete sensor element 212 and each of sensor columns 210ax-gx includes two discrete sensor elements 214 and 216. Sensor controller 204 includes a first set of channels 218ay-dy and a second set of channels 220ax-gx. Each of channels 218ay-dy is electrically connected to a respective sensor element 212 of a respective row 208ay-hy via a respective set of signal lines 222. Likewise, each of channels 220 is electrically connected to one of first sensor elements 214 of a respective sensor column 210ax-gx via a respective one of signal lines 224. Sensor controller 206 includes a first set of channels 226ey-hy and a second set of channels 228ax-gx. Each of channels 226ey-hy is electrically connected to a respective sensor element 212 of a respective row 208ey-hy via a respective one of signal lines 230. Likewise, each of channels 228ax-gx is electrically connected to a second sensor element 216 of a respective one of sensor columns 210ax-gx via a respective one of signal lines 232. The operation of system 200 is similar to that of touch system 100 except that system 200 can support larger screen areas because each of sensor

columns 210ax-gx includes two sensor elements (i.e. sensor elements 214 and 216) rather a single sensor column extending across the entire y distance of panel 202. Thus, the y-distance of panel 202 can be twice as long as that of panel 102.

Although system 200 can support a larger screen area than touch system 100, there are 5 still problems with the design. For example, the x-distance of panel 202 still has to be relatively short because each of sensor rows 208ay-hy only includes a single sensor element 212 that extends across the entire x-distance. Accordingly, the design of system 200 only relaxes the constraints in the y-length of panel 202 and, therefore, the constraints in the x-direction still exist. As another example, controllers 204 and 206, together, have a relatively 10 high number of channels (i.e., 218ay-dy, 220ax-gx, 226ey-hy, and 228ax-gx) in order to acquire the capacitive states of sensor elements 212, 214, and 216. In other words, system 200 has a high channel-to-sensor element ratio. Of course, as the number of required channels and, therefore, channel connections, increases, the overall reliability of system 200 decreases. Furthermore, the high number of channels also makes the manufacturing and assembly of 15 system 200 expensive because only controllers that support a high number channels can be used.

What is needed, therefore, is a capacitive touch system design that can be used in conjunction with larger display screens. What is also need is a capacitive touch system design that improves touch sensitivity without sacrificing optical clarity and/or reducing 20 sensor resolution. What is also needed is a capacitive touch system that has a lower channel-to-sensor element ratio. What is also needed is a capacitive touch system that has a higher reliability and cost less to manufacture.

SUMMARY

25 The present invention overcomes the problems associated with the prior art by providing a capacitive touch system that includes a first controller having a plurality of channels, a first sensor row having a first discrete sensor element and a second discrete sensor element, a second sensor row having a first discrete sensor element and a second discrete sensor element, a first sensor column, a second sensor column, and a first signal line 30 electrically coupling one channel of the plurality of channels of the controller to both the first and second discrete sensor elements of the first sensor row.

In a particular embodiment, the system further includes a second controller having a plurality of channels. In a more particular embodiment, the system further includes a second signal line electrically coupling a first channel of the second controller to both the first

discrete sensor element of the second sensor row and the second discrete sensor element of the second sensor row. In an even more particular embodiment, the first sensor column includes a first discrete sensor element and a second discrete sensor element, the first controller includes a second channel electrically coupled to the first discrete sensor element of the first sensor column via a third signal line, and the second controller includes a second channel electrically coupled to the second discrete sensor element of the first sensor column via a fourth signal line. In a more particular embodiment, the second sensor column includes a first discrete sensor element and a second discrete sensor element, the first controller includes a third channel electrically coupled to the first discrete sensor element of the second sensor column via a fifth signal line, and the second controller includes a third channel electrically coupled to the second discrete sensor element of the second sensor column via a sixth signal line.

In another particular embodiment, the system further includes a second controller having a first channel and a second channel, the first controller includes a second channel, the first sensor column includes a first discrete sensor element and a second discrete sensor element, and the second sensor column includes a first discrete sensor element and a second discrete sensor element. In a more particular embodiment, the first channel of the first controller is electrically connected to both the first discrete sensor element and the second discrete sensor element of the first sensor row via a first signal line. The first channel of the second controller is electrically connected to both the first discrete sensor element and the second discrete sensor element of the second sensor row via a second signal line. The second channel of the first controller is electrically connected to both the first discrete sensor element and the second discrete sensor element of the first sensor column via a third signal line. The second channel of the second controller is electrically connected to both the first discrete sensor element and the second discrete sensor element of the second sensor column via a fourth signal line.

In another more particular embodiment, the first channel of the first controller is electrically coupled to both the first and second discrete sensor elements of the first sensor row via a first signal line, the second channel of the first controller is electrically coupled to both the first and second discrete sensor elements of the second sensor row via a second signal line, the first channel of the first controller is electrically coupled to both the first and second discrete sensor elements of the first sensor column via a third signal line, and the second channel of the second controller is electrically coupled to both the first and second discrete sensor elements of the second sensor columns via a fourth signal line.

In yet another particular embodiment, the first sensor row includes a first discrete sensor element and a second discrete sensor element, the second sensor row includes a first discrete sensor element and a second discrete sensor element, the first column includes a first and second discrete sensor element, and the second column includes a first discrete sensor element and a second discrete sensor element. Further, the first controller includes a first channel, a second channel, a third channel, and a fourth channel. The first channel is electrically coupled to both the first and second discrete sensor elements of the first sensor row via a first signal line, the second channel is electrically coupled to both the first and second discrete sensor elements of the second sensor row via a second signal line, the third channel is electrically coupled to both the first and second discrete sensor elements of the first sensor column via a third signal line, and the fourth channel is electrically coupled to both the first and second discrete sensor elements of the second sensor column via a fourth signal line.

In the example embodiments, the discrete sensor elements are formed from a transparent conductive material such as, for example, indium tin oxide. Also in the example embodiments, each discrete sensor element includes a plurality diamond shapes connected in series. In addition, a first set of discrete sensor elements and a second set of discrete sensor elements are disposed in an overlayed relationship with a transparent and electrically insulating material disposed between the two sets (e.g., the sensor rows and the sensor columns) of discrete sensor elements.

In the example embodiments, at least some of the sensor elements are open ended electrodes that are electrically connected to the channels of the controllers in parallel.

According to one method of detecting a touch, the capacitive state of the first discrete sensor element and the second discrete sensor element of the first sensor row are measured simultaneously at a common node.

25

BRIEF DESCRIPTION OF THE DRAWINGS

The present invention is described with reference to the following drawings, wherein like reference numbers denote substantially similar elements:

- FIG. 1 is a diagram of a prior art capacitive touch system;
- 30 FIG. 2 is a diagram of another prior art capacitive touch system;
- FIG. 3 a partially cut-away, perspective view of a capacitive touch system shown incorporated into a host device, according to one embodiment of the present invention;
- FIG. 4 is a block diagram illustrating the electrical communication between the capacitive touch system of FIG. 3 and a circuit board of the host device;

FIG. 5 is an exploded, perspective view of a sensor panel of the capacitive touch system of FIG. 3;

FIG. 6 is a diagram illustrating the electrical connections between a sensor panel, a first controller, and a second controller; and

5 FIG. 7 is a diagram illustrating the electrical connections between a sensor panel, an alternate first controller, and an alternate second controller, according to another embodiment of the present invention.

DETAILED DESCRIPTION

10 The present invention overcomes the problems associated with the prior art, by providing a capacitive touch system that can support larger display sizes. In the following description, numerous specific details are set forth (e.g., number of sensor rows and columns, specific sensor element patterns, etc.) in order to provide a thorough understanding of the invention. Those skilled in the art will recognize, however, that the invention may be
15 practiced apart from these specific details. In other instances, details of well known sensor data acquisition practices (e.g., noise filtering, signal amplification, multiplexing, self capacitance measuring, etc.) and components have been omitted, so as not to unnecessarily obscure the present invention.

FIG. 3 shows a perspective view of a capacitive touch system 300 according to one
20 embodiment of the present invention. In this example, capacitive touch system 300 is the primary user input/output system of a host device 302 that represents a capacitive touch system hosting device (e.g., tablet computer, PDA, MP3 player, cell phone, etc.). Hosting device 302 further includes a circuit board 304 and a housing 306. Circuit board 304 represents the main circuitry of host device 302 that carries out general computing operations
25 such as data communication, processing, storage, etc. Housing 306 includes a bezel 308 and a rear cover 310 coupled to one another from opposite sides of device 302 so as to protect the inner components of device 302, while also permitting direct interaction between a user and capacitive touch system 300. Those skilled in the art will recognize that, apart from
30 capacitive touch system 300, specific details related to host device 302 will vary depending on the application and are not particularly relevant to the present. Therefore, circuit board 304 and housing 306 are representational in character only.

Capacitive touch system 300 includes a graphical display device 312, a capacitive sensor panel 314, and two controllers 316 and 318 (both controllers shown in FIG. 5). Graphical display device 312 is, for example, a liquid crystal display (LCD) having a top

surface 320 that defines screen 322 for displaying graphical output information. Further, graphical display device 312 is mounted on and electrically coupled to circuit board 304 so as to facilitate data communication therebetween. Sensor panel 314 is a transparent capacitive touch-sensing device that receives user inputs from a target object (e.g., finger, stylus, etc.) by 5 detecting the presence of its electrical charge at specific locations within a two-dimensional xy region. Sensor panel 314 and graphical display device 312 are coupled together in a stacked relationship wherein sensor panel 314 is mounted on top surface 320 over screen 322. Accordingly, graphical output information from screen 322 is displayed through sensor panel 314. Each of controllers 316 and 318 is, for example, a microcontroller chip that acquires 10 sensor data from a respective different region of sensor panel 314. Further, controllers 316 and 318 are electrically coupled to circuit board 304 so that sensor data indicative of the target object's location can be communicated to and further processed by the processing circuitry of circuit board 304. Those skilled in the art will recognize that the specific locations of controllers 316 and 318 are not particularly relevant to the present invention. 15 However, the electrical connections between controllers 316, 318, and sensor panel 314 are particularly important and, therefore, will be discussed in detail below with reference to FIG. 6.

FIG. 4 is a block diagram that illustrates electrical communication between touch system 300 and circuit board 304 of host device 302. As shown, controller 316 and 318 20 communicate with sensor panel 314. More specifically, each of controllers 316 and 318 acquires sensor measurements from a different region of sensor panel 314. Controllers 316 and 318 process the measurements and generate data that is indicative of the target object's location. Then, the data is converted into a format that can be communicated to circuit board 304. Circuit board 304 receives the position data from both controllers 316 and 318 for 25 further processing. Circuit board 304 also communicates with graphical display device 312 to provide data and instructions indicative of graphical information that is to be displayed by screen 322. Although not shown, it typically a display driver would facilitate communication between circuit board 304 and graphical display device 312. However, the specific details 30 associated with graphical display device 312 and, as previously mentioned, circuit board 304 are not particularly relevant to the present invention, and so will not be disclosed in greater detail.

FIG. 5 shows a perspective view of sensor panel 314 exploded along an axis 500. In this particular embodiment, sensor panel 314 is a transparent composite structure composed of a first substrate 502, a plurality of sensor rows 504ay-hy, a second transparent substrate

506, and a plurality of sensor columns 508_{ax-gx}. As shown, substrate 502 is disposed above rows 504_{ay-hy}, rows 504_{ay-hy} are disposed between substrate 502 and substrate 506, substrate 506 is disposed between rows 504_{ay-hy} and columns 508_{ax-gx}, and columns 508_{ax-gx} are disposed below substrate 506.

5 Substrate 502 is a rigid, transparent, and electrically insulating structure such as, for example, a thin glass plate. Further, substrate 502 includes a top surface 510 and an opposite bottom planar surface 512. Top surface 510 defines a planar touch surface that is contacted by a target object during user input events. Note that, to avoid confusion, various aspects of panel 314 will be described with reference to a two-dimensional xy-plane shown on top 10 surface 510.

Sensor rows 504_{ay-hy} are arranged in the y-direction and extend across panel 314 in the x-direction such that each of rows 504_{ay-hy} is located at a different y-location. Each of sensor rows 504_{ay-hy} includes a first discrete sensor element 514 and a second discrete sensor element 516 extending toward one another from opposite directions such that each occupies a 15 different region of the same row. Although each pair of sensor elements 514 and 516 occupies a different region of the same row, they are aligned to correspond with the same y-coordinate. In this particular embodiment, each of sensor elements 514 and 516 is composed of a transparent conductive material (e.g., ITO) that is patterned on substrate 502 to define a series of connected diamond shapes arranged along the x-direction. Because sensor elements 20 514 and 516 are composed of a conductive material, each has a measurable self capacitance which changes in the presence of a target object (e.g., a finger, a stylus, etc.).

Substrate 506 is similar to substrate 502 in that it is a rigid, transparent, and electrically insulating structure such as, for example, a thin glass plate. Further, substrate 506 includes a top surface 518 and an opposite bottom planar surface 520. Substrate 506 acts as 25 an insulating barrier between sensor rows 504_{ay-hy} and sensor columns 508_{ax-gx}.

Sensor columns 508_{ax-gx} are spaced along the x-direction and extend across panel 314 in the y-direction such that each of columns 508_{ax-gx} is located at different x-locations. Each of sensor columns 508_{ax-gx} includes a first discrete sensor element 522 and a second discrete sensor element 524 extending toward one another from opposite directions such that each 30 occupies a different region of the same column. Although each pair of sensor elements 522 and 524 occupies a different region of the same column, they are aligned to correspond with the same x-coordinate. In this particular embodiment, each of sensor elements 522 and 524 is composed of a transparent conductive material (e.g., ITO) that is patterned on substrate 506 to define series of connected diamond shapes arranged along the y-direction. Like sensor

elements 514 and 516, sensor elements 522 and 524 are also composed of a conductive material and, therefore, also have a measurable self capacitance which changes in the presences of a target object.

In this particular embodiment, sensor rows 504 and sensor columns 508 are formed by 5 depositing an ITO layer directly on bottom surface 512 of substrate 502 and bottom surface 520 of substrate 506, respectively, by some suitable means such as, for example, sputter deposition. Then, the ITO layer formed on surface 512 is etched to define sensor elements 514 and 516, and the ITO layer formed on surface 520 is etched to define sensor elements 522 and 524. After the ITO layers are etched, substrates 502 and 506 are permanently 10 bonded to one another in a stacked relation such that bottom surface 512 of substrate 502, having sensor rows 504 formed thereon, is bonded to top surface 518 of substrate 506 via, for example, a transparent non-conductive pressure sensitive adhesive (PSA) disposed therebetween. Similarly, sensor panel 314 is mounted on graphical display 312 such that bottom surface 520 of substrate 506, having sensor columns 508 formed thereon, is bonded to 15 top surface 320 of graphical display device 312 via, for example, a PSA disposed therebetween.

FIG. 6 is a schematic circuit diagram illustrating the circuitry between sensor panel 314, first controller 316, and second controller 318. As previously mentioned, each of controllers 316 and 318 is operative to control a different region of touch-sensor panel 314. 20 More specifically, first controller 316 controls sensor rows 504_{ay-dy} and each first discrete sensor element 522 of sensor columns 508_{ax-gx}. Controller 318 controls sensor rows 504_{ey-hy} and each second discrete sensor element 524 of sensor columns 508_{ax-gx}. Controller 316 includes a first set of channels 602_{ay-dy} (a plurality of separate inputs) and a second set of channels 604_{ax-gx} (another plurality of separate inputs). Similarly, controller 318 includes a 25 first set of channels 606_{ey-hy} and a second set of channels 608_{ax-gx}.

First channels 602_{ay-dy} of controller 316 are electrically connected to respective sensor rows 504_{ay-dy} via a set of signal lines 610. More specifically, each of signal lines 610 electrically connects one of channels 602_{ax-gx} to the first sensor element 514 and the second sensor element 516 of a respective one of rows 504_{ay-dy}. That is, channel 602_{ay} is 30 electrically connected to both sensor elements 514 and 516 of respective sensor row 504_{ay} via a first one signal lines 610, channel 602_{by} is electrically connected to both sensor elements 514 and 516 of respective sensor row 504_{by} via a second one of signal lines 610, channel 602_{cy} is electrically connected to both sensor elements 514 and 516 of respective sensor row 504_{cy} via a third one signal lines 610, and channel 602_{dy} is electrically connected to both

sensor elements 514 and 516 of respective sensor row 504dy via a fourth one signal lines 610. Accordingly, each pair of sensor elements 514 and 516 of sensor rows 504ay-dy share a common node with a respective one of channels 602ay-dy.

Second channels 604ax-gx are electrically connected first sensor elements 522 of respective sensor columns 508ax-gx via a set of signal lines 612. That is, channel 604ax is electrically connected to sensor element 522 of respective sensor column 508ax via a first one signal lines 612, channel 604bx is electrically connected to sensor element 522 of respective sensor column 508bx via a second one of signal lines 612, channel 604cx is electrically connected to sensor element 522 of respective sensor column 508cx via a third one of signal lines 612, channel 604cx is electrically connected to sensor element 522 of respective sensor column 508cx via a third one of signal lines 612, channel 604dx is electrically connected to sensor element 522 of respective sensor column 508dx via a fourth one of signal lines 612, channel 604ex is electrically connected to sensor element 522 of respective sensor column 508ex via a fifth one of signal lines 612, channel 604fx is electrically connected to sensor element 522 of respective sensor column 508fx via a sixth one of signal lines 612, and channel 604gx is electrically connected to sensor element 522 of respective sensor column 508gx via a seventh one of signal lines 612. Accordingly, each of channels 604ax-gx shares a common node with a respective one of sensor elements 522.

First channels 606ey-hy of controller 318 are electrically connected to respective sensor rows 504ey-hy via a set of signal lines 614. More specifically, each of signal lines 614 electrically connects one of channels 606ex-hx to the first sensor element 514 and second sensor element 516 of a respective one of rows 504ey-hy. That is, channel 606ey is electrically connected to both sensor elements 514 and 516 of respective sensor row 504ey via a first one signal lines 614, channel 606fy is electrically connected to both sensor elements 514 and 516 of respective sensor row 504fy via a second one of signal lines 614, channel 606gy is electrically connected to both sensor elements 514 and 516 of respective sensor row 504gy via a third one signal lines 614, and channel 606hy is electrically connected to both sensor elements 514 and 516 of respective sensor row 504hy via a fourth one signal lines 614. Accordingly, each pair of sensor elements 514 and 516 of sensor rows 504ey-hy share a common node with a respective one of channels 608ey-hy.

Second channels 608ax-gx are electrically connected second sensor elements 524 of respective sensor columns 508ax-gx via a set of signal lines 616. That is, channel 608ax is electrically connected to sensor element 524 of respective sensor column 508ax via a first one signal lines 616, channel 608bx is electrically connected to sensor element 524 of respective

sensor column 508bx via a second one of signal lines 616, channel 608cx is electrically connected to sensor element 524 of respective sensor column 508cx via a third one of signal lines 616, channel 608cx is electrically connected to sensor element 524 of respective sensor column 508cx via a third one of signal lines 616, channel 608dx is electrically connected to
5 sensor element 524 of respective sensor column 508dx via a fourth one of signal lines 616, channel 608ex is electrically connected to sensor element 524 of respective sensor column 508ex via a fifth one of signal lines 616, channel 608fx is electrically connected to sensor element 524 of respective sensor column 508fx via a sixth one of signal lines 616, and channel 608gx is electrically connected to sensor element 524 of respective sensor column
10 508gx via a seventh one of signal lines 616. Accordingly, each of channels 608ax-gx shares a common node with a respective one of sensor elements 524.

During operation, the capacitive state of each individual one of sensor rows 504ay-dy is measured at a respective one of channels 602ay-gy, the capacitive state of each sensor element 522 of columns 508ax-gx is measured at respective channels 604ax-gx, the capacitive state of each individual one sensor rows 504ey-hy is measured at a respective one of channels 606ey-hy, and the capacitive state of each sensor element 524 of columns 508ax-gx is measured at respective channels 608ax-gx. It follows that when a touch event takes place on the lower half of surface 510, the measurements acquired at channels 602ay-dy and channels 604 ax-gx correspond with a y-coordinate and an x-coordinate, respectively, that, together,
15 20 define the location of the target object. When a touch event takes place on the upper half of surface 510, the measurements acquired at channels 606ey-hy and channels 608ax-gx correspond with a y-coordinate and x-coordinate, respectively, indicative of the target object location.

Because each first sensor element 514 shares a common node with a respective one of second sensor elements 516, the total capacitive state of a pair of sensor elements 514 and 516 is simultaneously measured at single channel. Of course, this measurement corresponds to the capacitive state of the sensor row at which the pair of sensor elements is located. It should be recognized that this enables sensor rows 504ay-hy to be twice as long as those of prior art sensor rows 208ay-hy without increasing the number of required controller channels,
25 30 sacrificing optical clarity, reducing touch sensitivity, and/or reducing sensor resolution. Indeed, sensor panel 314 can support the same surface area as that of sensor panel 202 using half the number of channels to measure sensor row capacitance. By decreasing the number of controller channels in system 300, reliability is improved, controller design is simplified, and

the overall manufacturing cost is reduced when compared to prior art capacitive touchscreen systems.

FIG. 7 is a schematic circuit diagram illustrating an alternative embodiment 700 of the present invention, wherein sensor panel 314 is shown electrically connected to a different first controller 702 and second controller 704. In this particular embodiment, sensor rows 504ay-dy and sensor columns 508ex-gx are controlled/monitored by controller 702 while sensor rows 504ey-hy and sensor columns 508ax-dx are controlled/monitored by controller 704. Controller 702 includes a first set of channels 706ay-dy and a second set of channels 708ex-gx. Similarly, controller 704 includes a first set of channels 710ey-hy and a second set of channels 712ax-dx.

First channels 706ay-dy are electrically connected to respective sensor rows 504ay-dy via a set of signal lines 714. More specifically, each of signal lines 714 electrically connects one of channels 706ay-dy to the first sensor element 514 and the second sensor element 516 of a respective one of rows 504ay-dy. That is, channel 706ay is electrically connected to both sensor elements 514 and 516 of respective sensor row 504ay via a first one signal lines 714, channel 706by is electrically connected to both sensor elements 514 and 516 of respective sensor row 504by via a second one of signal lines 714, channel 706cy is electrically connected to both sensor elements 514 and 516 of respective sensor row 504cy via a third one signal lines 714, and channel 706dy is electrically connected to both sensor elements 514 and 516 of respective sensor row 504dy via a fourth one signal lines 714. Accordingly, each pair of sensor elements 514 and 516 of sensor rows 504ay-dy shares a common node with a respective one of channels 706ay-dy.

Second channels 708ex-gx of controller 702 are electrically connected to respective sensor columns 508ex-gx via a set of signal lines 716. More specifically, each of signal lines 716 electrically connects one of channels 708ex-gx to the first sensor element 522 and second sensor element 524 of a respective one of columns 508ex-gx. That is, channel 708ex is electrically connected to both sensor elements 522 and 524 of respective sensor column 508ex via a first one of signal lines 714, channel 708fx is electrically connected to both sensor elements 522 and 524 of respective sensor column 508fx via a second one of signal lines 714, and channel 708gx is electrically connected to both sensor elements 522 and 524 of respective sensor column 508gx via a third one of signal lines 714. Accordingly, each pair of sensor elements 522 and 524 of sensor columns 508ex-gx shares a common node with a respective one of channels 708ex-gx.

First channels 710ey-hy of controller 704 are electrically connected to respective sensor rows 504ey-hy via a set of signal lines 718. More specifically, each of signal lines 718

electrically connects one of channels 710ey-hy to the first sensor element 514 and second sensor element 516 of a respective one of rows 504ey-hy. That is, channel 710ey is electrically connected to both sensor elements 514 and 516 of respective sensor row 504ey via a first one signal lines 718, channel 710fy is electrically connected to both sensor elements 514 and 516 of respective sensor row 504fy via a second one of signal lines 718, channel 710gy is electrically connected to both sensor elements 514 and 516 of respective sensor row 504gy via a third one signal lines 718, and channel 710hy is electrically connected to both sensor elements 514 and 516 of respective sensor row 504hy via a fourth one signal lines 718. Accordingly, each pair of sensor elements 514 and 516 of sensor rows 504ey-hy shares a common node with a respective one of channels 710ey-hy.

Second channels 712ax-dx of controller 704 are electrically connected to respective sensor columns 508ax-dx via a set of signal lines 720. More specifically, each of signal lines 720 electrically connects one of channels 712ax-dx to the first sensor element 522 and second sensor element 524 of a respective one of columns 508ax-dx. That is, channel 712ax is electrically connected to both sensor elements 522 and 524 of respective sensor column 508ax via a first one of signal lines 720, channel 712bx is electrically connected to both sensor elements 522 and 524 of respective sensor column 508bx via a second one of signal lines 720, channel 712cx is electrically connected to both sensor elements 522 and 524 of respective sensor column 508cx via a third one of signal lines 720, and channel 712dx is electrically connected to both sensor elements 522 and 524 of respective sensor column 508dx via a fourth one of signal lines 720. Accordingly, each pair of sensor elements 522 and 524 of sensor columns 508ax-dx shares a common node with a respective one of channels 712ax-dx.

Because each first sensor element 514 shares a common node with a respective one of second sensor elements 516, the total capacitive state of a pair of sensor elements 514 and 516 is simultaneously measured at a single channel. Likewise, each first sensor element 522 shares a common node with a respective one of second sensor elements 522 such that the total capacitive state of a pair of sensor elements 522 and 524 is also simultaneously measured at single channel. Accordingly, the total number of channels required to measure the capacitive state of columns 508ax-gx is effectively reduced to half the total number of channels required to measure the capacitive state of prior art sensor columns 210ax-gx shown in FIG. 2. Not only are far fewer channels required, sensor panel 314 can achieve at least the same touch sensitivity, optical clarity, and touch resolution on a significantly larger screen. Of course, with like screen sizes, sensor panel 314 can be optimized to achieve significantly higher sensitivity, optical clarity, and touch resolution than can prior art sensor panel 202.

Although not shown, the circuitry of diagram 700 could optionally be arranged such that channels 706ay-dy and 710ey-hy are located on controller 702, and channels 712ax-dx and 708ex-gx are located on controller 704. In such a case, controller 702 would be responsible for controlling all of sensor rows 504ay-hy while controller 704 would be responsible for 5 controlling all of sensor columns 508ax-gx. Thus, the y-coordinate of the touch location would be generated from controller 702 and the x-coordinate from controller 704.

The description of particular embodiments of the present invention is now complete. Many of the described features may be substituted, altered or omitted without departing from the scope of the invention. For example, alternate conductive substrates (e.g., aluminum zinc 10 oxide), may be used in place of ITO. As another example, alternate transparent insulating (e.g., polycarbonate) substrates may be substituted for the glass plates. As yet another example, although the rows/columns of the disclosed embodiments are each divided into two discrete sensor elements, touch panel size can be further increased by including three or more discrete sensor elements in each column or row. These and other deviations from the 15 particular embodiments shown will be apparent to those skilled in the art, particularly in view of the foregoing disclosure.

We claim:

- 1 1. A capacitive touch sensor system comprising:
2 a first controller having a plurality of channels;
3 a first sensor row extending along a first direction, said first sensor row having a first
4 discrete sensor element and a second discrete sensor element;
5 a second sensor row extending along said first direction, said second sensor row
6 having a first discrete sensor element and a second discrete sensor element;
7 a first sensor column extending along a second direction;
8 a second sensor column extending along said second direction;
9 a first signal line electrically coupling a first channel of said plurality of channels of
10 said controller to said first discrete sensor element of said first sensor row and said
11 second discrete sensor element of said first row.
- 1 2. A capacitive touch sensor system according to Claim 1, further comprising a
2 second controller having a plurality of channels.
- 1 3. A capacitive touch sensor system according to Claim 2, further comprising a
2 second signal line electrically coupling a first one of said plurality of channels of said second
3 controller to said first discrete sensor element of said second sensor row and said second
4 discrete sensor element of said second sensor row.
- 1 4. A capacitive touch sensor system according to Claim 3, wherein
2 said first sensor column includes a first discrete sensor element and a second discrete
3 sensor element;
4 said plurality of channels of said first controller includes a second channel;
5 said plurality of channels of said second controller includes a second channel; and
6 said capacitive touch sensor system further comprises a third signal line and a fourth
7 signal line, said third signal line electrically coupling said second channel of said
8 first controller to said first discrete sensor element of said first sensor column and
9 said fourth signal line electrically coupling said second channel of said second
10 controller to said second discrete sensor element of said first sensor column.

1 5. A capacitive touch sensor system according to Claim 4, wherein
2 said second sensor column includes a first discrete sensor element and a second
3 discrete sensor element;
4 said plurality of channels of said first controller includes a third channel;
5 said plurality of channels of said second controller includes a third channel; and
6 said capacitive touch sensor system further comprises a fifth signal line and a sixth
7 signal line, said fifth signal line electrically coupling said first discrete sensor
8 element of said second sensor column and said third channel of said first
9 controller, said sixth signal line electrically coupling said second discrete sensor
10 element of said second sensor column and said third channel of said second
11 controller.

1 6. A capacitive touch sensor system according to Claim 5, wherein said discrete
2 sensor elements are formed from a transparent conductive material.

1 7. A capacitive touch sensor system according to Claim 6, wherein said transparent
2 conductive material is indium tin oxide.

1 8. A capacitive touch sensor system according to Claim 7, wherein said discrete
2 sensor elements include a plurality of diamond shaped segments of said conductive material
3 connected in series.

1 9. A capacitive touch sensor system according to Claim 3, wherein
2 said first sensor column includes a first discrete sensor element and a second discrete
3 sensor element;
4 said plurality of channels of said first controller includes a second channel; and
5 said capacitive touch sensor system further comprises a third signal line and a fourth
6 signal line, said third signal line electrically coupling said second channel of said
7 first controller to said first discrete sensor element of said first sensor column and
8 said second discrete element of said first sensor column.

1 10. A capacitive touch sensor system according to Claim 9, wherein
2 said second sensor column includes a first discrete sensor element and a second
3 discrete sensor element;
4 said second controller includes a second channel; and
5 said capacitive touch sensor system further comprises a fourth signal line electrically
6 coupling said second channel of said second controller to said first discrete sensor
7 element of said second sensor column and said second discrete sensor element of
8 said second sensor column.

1 11. A capacitive touch sensor system according to Claim 1, further comprising a
2 second signal line electrically coupling a second channel of said first controller to said first
3 discrete sensor element of said second sensor row and said second discrete sensor element of
4 said second sensor row.

1 12. A capacitive touch sensor system according to Claim 11, wherein
2 said first sensor column includes a first discrete sensor element and a second discrete
3 sensor element;
4 said plurality of channels of said first controller includes a third channel; and
5 said capacitive touch sensor system further comprises a third signal line electrically
6 coupling said third channel of said first controller to said first discrete sensor
7 element of said first sensor column and said second discrete sensor element of said
8 first sensor column.

1 13. A capacitive touch sensor system according to Claim 12, wherein
2 said second sensor column includes a first discrete sensor element and a second
3 discrete sensor element;
4 said plurality of channels of said first controller includes a fourth channel; and
5 said capacitive touch sensor system further comprises a fourth signal line electrically
6 coupling said fourth channel of said first controller to said first discrete sensor
7 element of said second sensor column and said second discrete sensor element of
8 said second sensor column.

1 14. A capacitive touch sensor system according to Claim 11, further comprising a
2 second controller having a plurality of channels.

1 15. A capacitive touch sensor system according to Claim 14, wherein
2 said first sensor column includes a first discrete sensor element and a second discrete
3 sensor element;
4 said plurality of channels of said second controller includes a first channel; and
5 said capacitive touch sensor system further comprises a third signal line electrically
6 coupling said first channel of said second controller to said first discrete sensor
7 element of said first sensor column and said second discrete sensor element of said
8 first sensor column.

1 16. A capacitive touch sensor system according to Claim 15, wherein
2 said second sensor column includes a first discrete sensor element and a second
3 discrete sensor element;
4 said plurality of channels of said second controller includes a second channel; and
5 said capacitive touch sensor system further comprises a fourth signal line electrically
6 coupling said second channel of said second controller to said first discrete sensor
7 element of said second sensor column and said second discrete sensor element of
8 said second sensor column.

1 17. A capacitive touch sensor system according to Claim 1, wherein said discrete
2 sensor elements are formed of a transparent conductive material.

1 18. A capacitive touch sensor system according to Claim 17, wherein said transparent
2 conductive material is indium tin oxide.

1 19. A capacitive touch sensor system according to Claim 18, wherein:
2 said transparent conductive material defines a first set of discrete sensor elements and
3 a second set of sensor elements;
4 each discrete sensor element of said first set of discrete sensor elements includes a
5 chain of diamond shapes connected in series along said first direction;
6 each discrete sensor element of said second set of discrete sensor elements includes a
7 chain of diamond shapes connected in series along said second direction;
8 said first set of discrete sensor elements and said second set of discrete sensor
9 elements are disposed in an overlayed relationship so as to form a two-
10 dimensional array of diamond shapes; and
11 said first set of discrete sensor elements and said second set of discrete sensor
12 elements are electrically insulated from one another.

1 20. A capacitive touch sensor system according to Claim 1, wherein said sensor rows
2 are formed on a first rigid transparent substrate and said sensor columns are formed on a
3 second rigid transparent substrate.

1 21. A capacitive touch sensor system according to Claim 1, further comprising a
2 transparent and electrically insulating material disposed between said sensor rows and said
3 sensor columns.

1 22. A capacitive touch sensor system according to Claim 1, wherein the capacitive
2 state of said first discrete sensor element of said first sensor row and said second discrete
3 sensor element of said first sensor row are measured simultaneously at a common node.

1 23. A capacitive touch sensor system according to Claim 1, wherein said first discrete
2 sensor element and said second discrete sensor element are open ended electrodes being
3 electrically connected in parallel.

1 24. A capacitive touch system according to Claim 1, wherein said first direction is
2 orthogonal to said second direction.

1 25. A touch display system comprising:
2 a controller having a plurality of channels;
3 a display;
4 a first sensor row overlying said display and extending along a first direction, said
5 first sensor row having a first discrete sensor element and a second discrete sensor
6 element;
7 a second sensor row overlying said display and extending along said first direction,
8 said second sensor row having a first discrete sensor element and a second discrete
9 sensor element;
10 a first sensor column overlying said display and extending along a second direction;
11 a second sensor column overlying said display and extending along said second
12 direction;
13 a first signal line electrically coupling a first one of said plurality channels of said
14 controller to said first discrete sensor element of said first sensor row and said
15 second discrete sensor element of said first sensor row.

1 26. A capacitive touch system comprising:
2 a controller having a plurality of channels;
3 a first sensor row extending along a first direction, said first sensor row having a first
4 discrete sensor element and a second discrete sensor element;
5 a second sensor row extending along said first direction, said second sensor row
6 having a first discrete sensor element and a second discrete sensor element;
7 a first sensor column extending along a second direction;
8 a second sensor column extending along said second direction;
9 means for coupling a first one of said plurality channels of said controller to said first
10 discrete sensor element of said first sensor row and said second discrete sensor
11 element of said first sensor row.

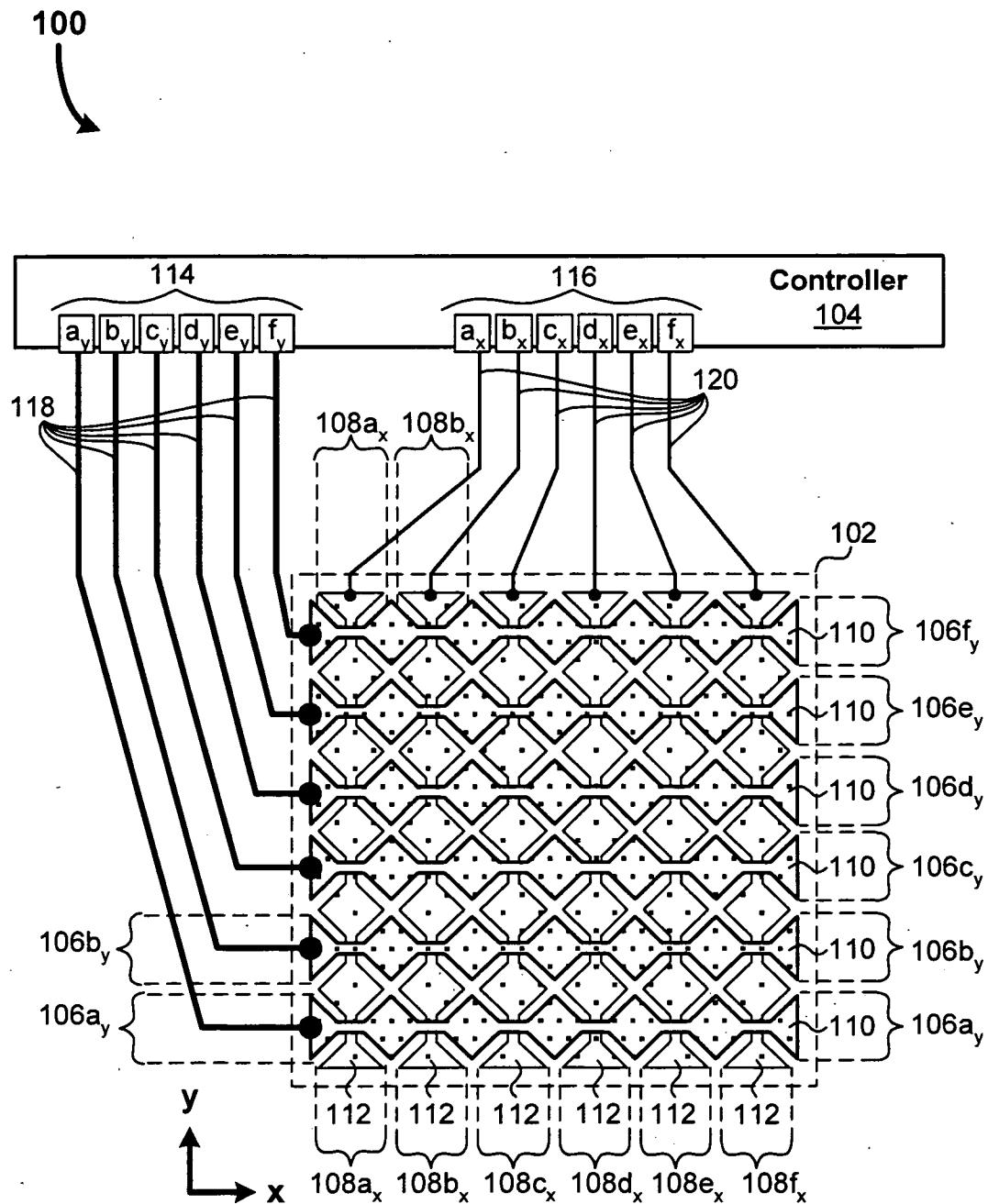


FIG. 1
(PRIOR ART)

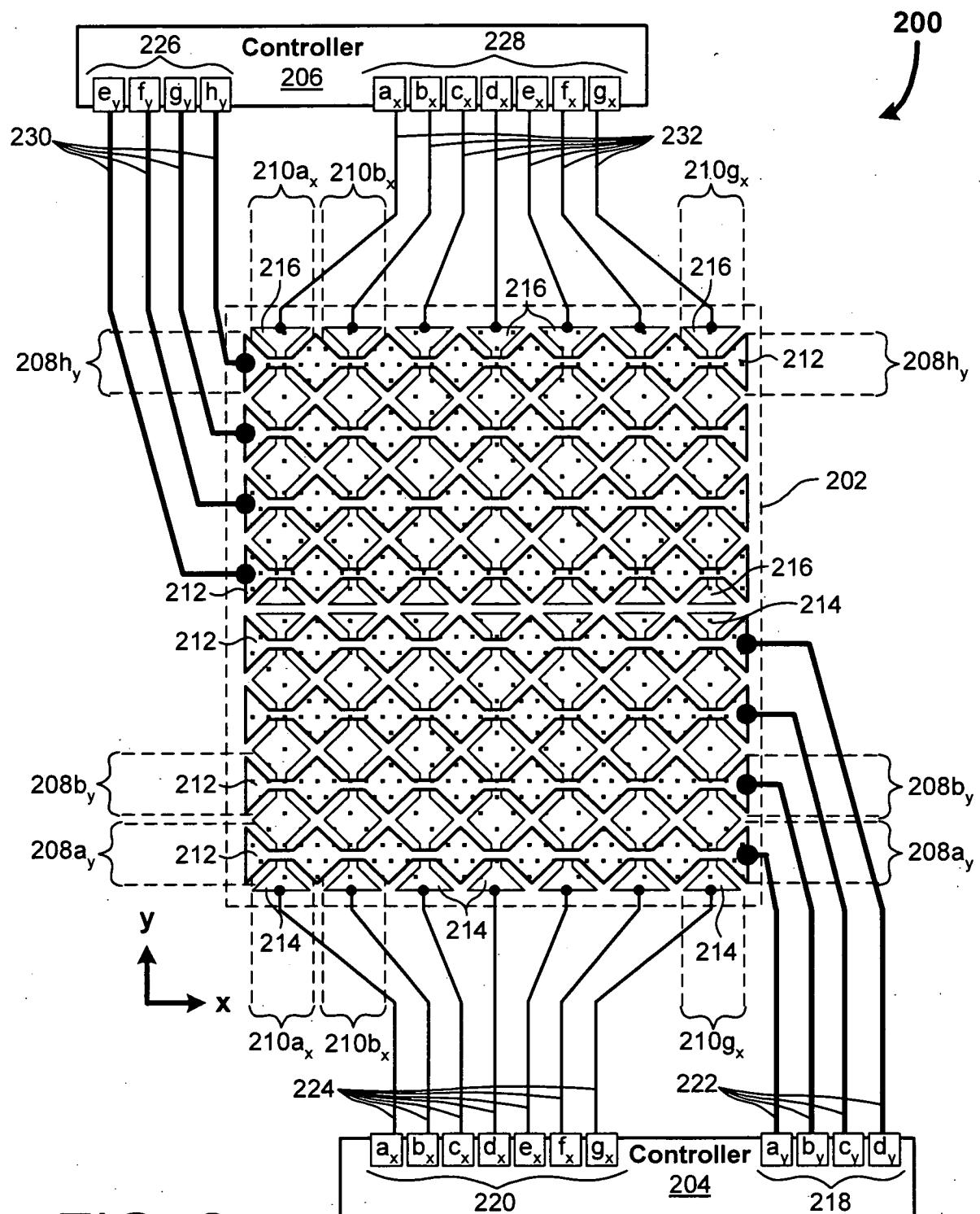


FIG. 2
(PRIOR ART)

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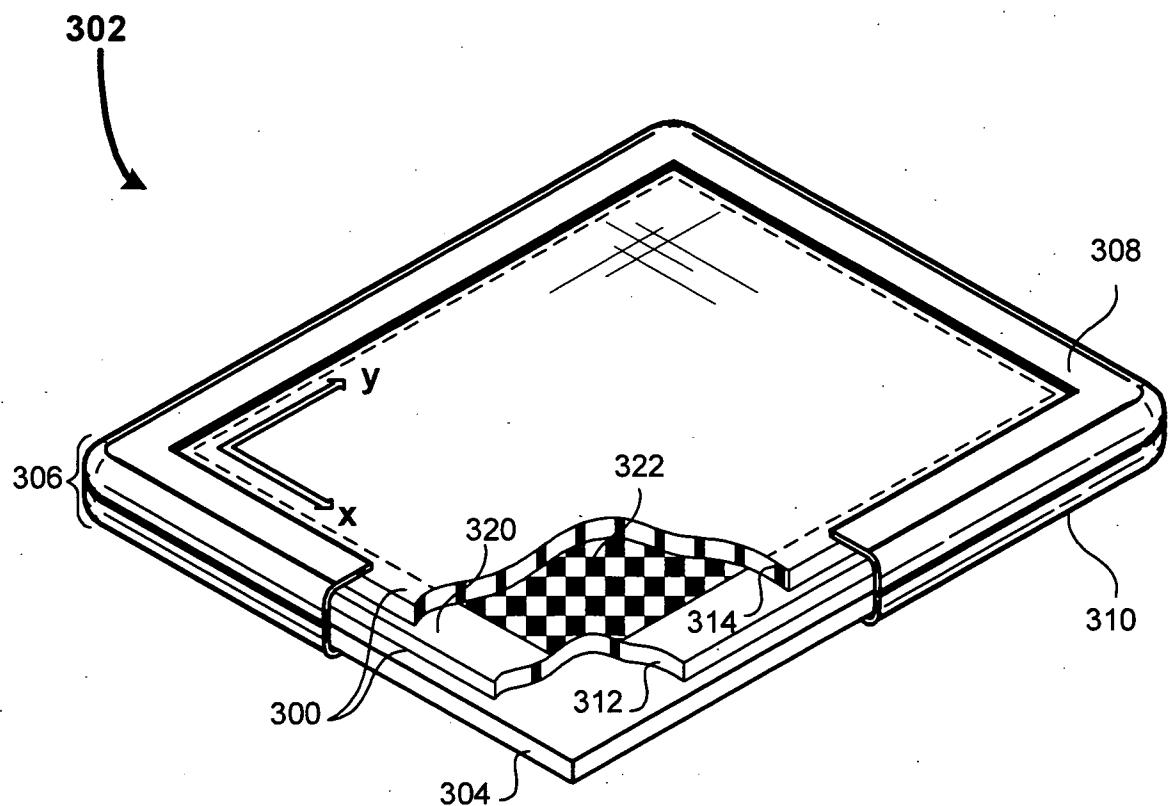


FIG. 3

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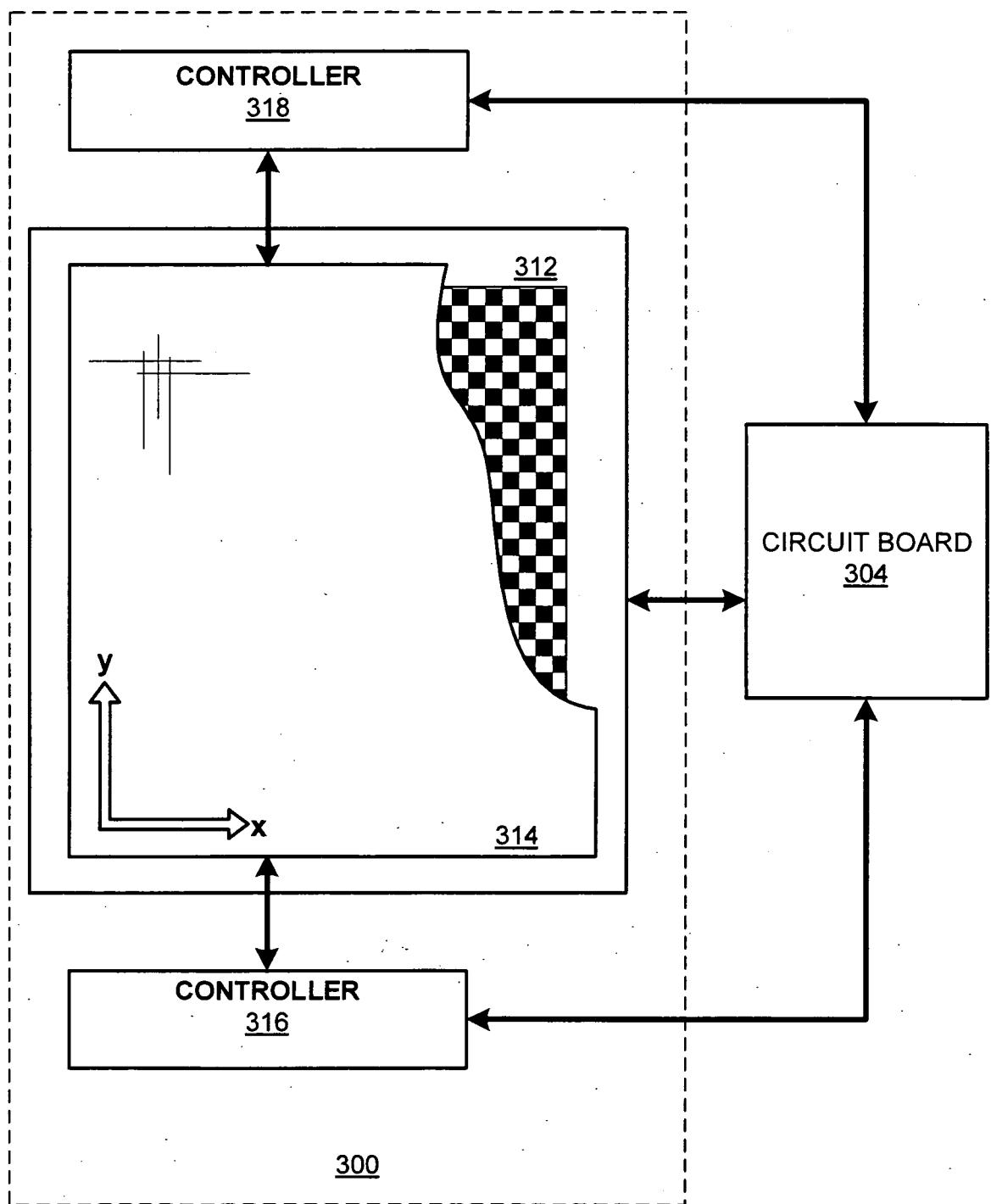


FIG. 4

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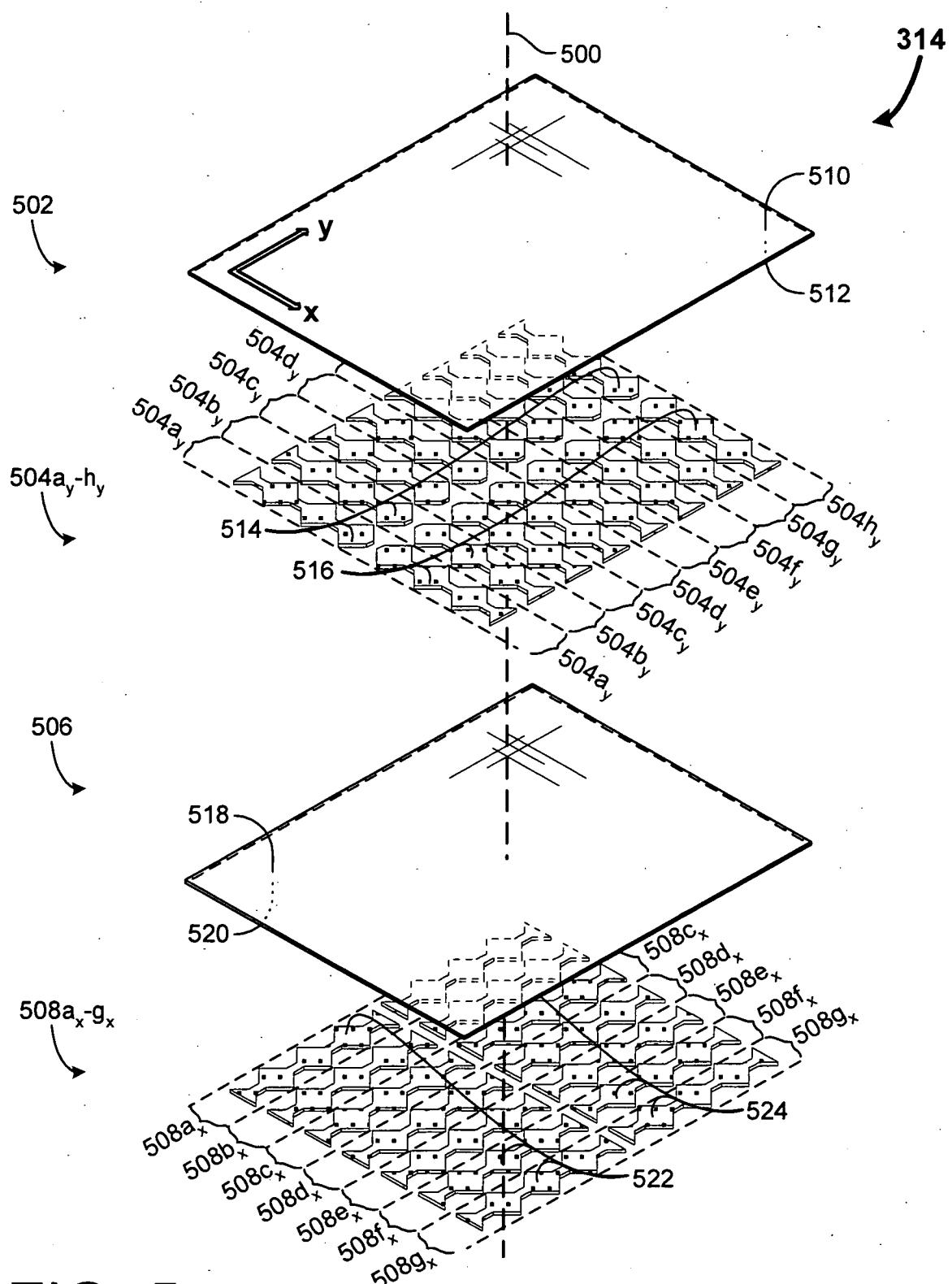


FIG. 5

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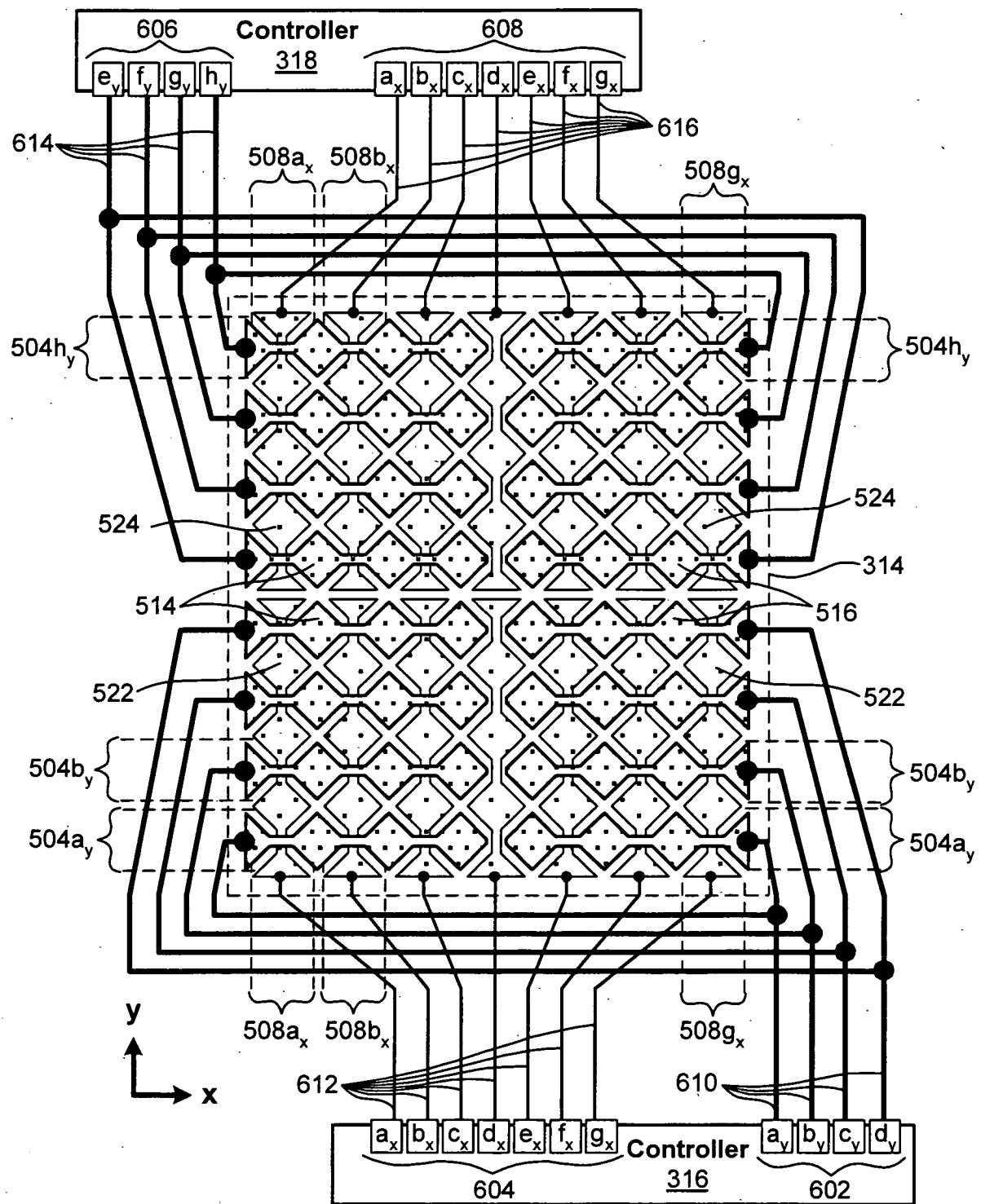


FIG. 6

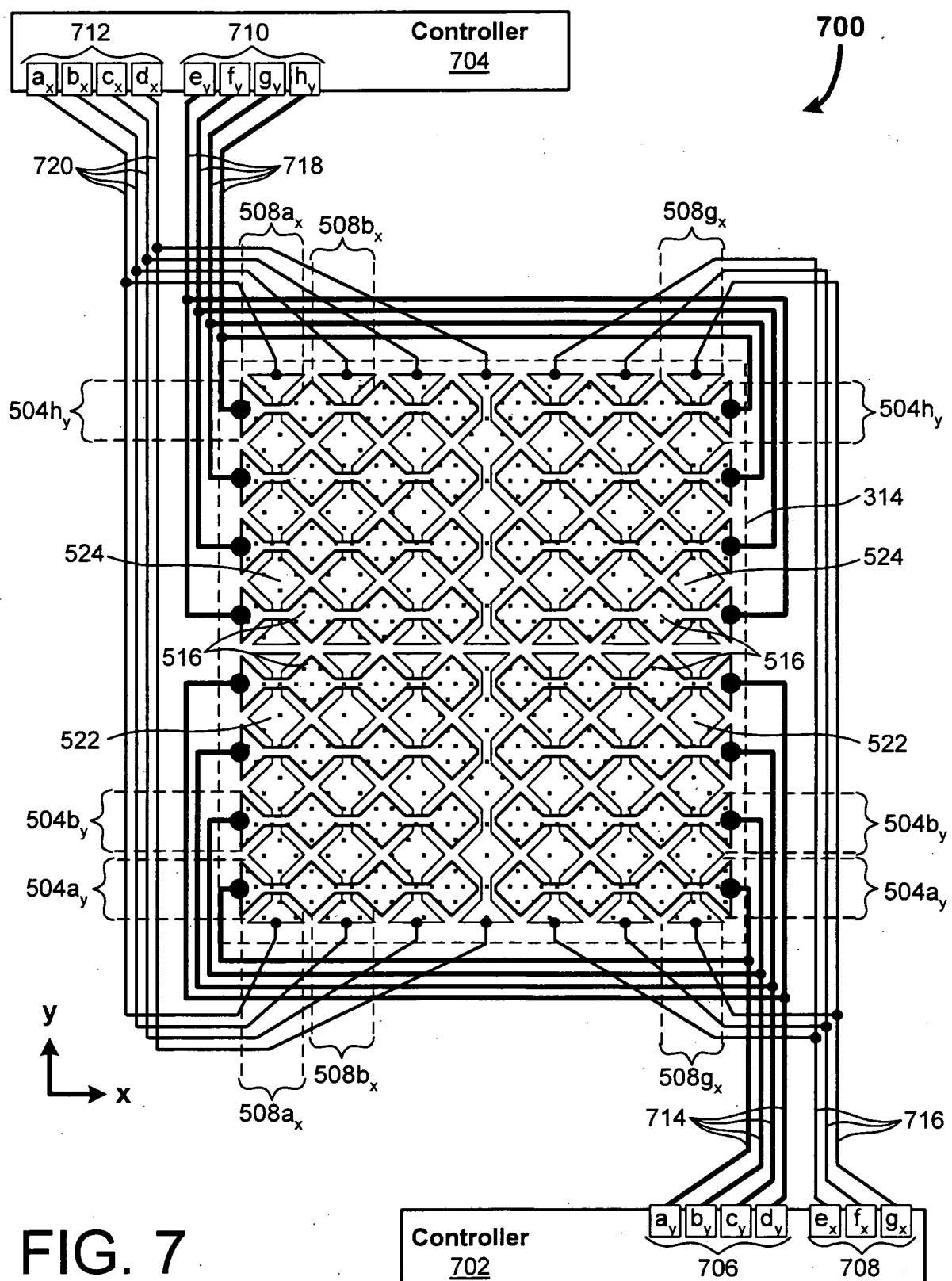


FIG. 7

INTERNATIONAL SEARCH REPORT

International application No.

PCT/US 10/03153

A. CLASSIFICATION OF SUBJECT MATTER

IPC(8) - G06F 3/041 (2011.01)

USPC - 345/173

According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)
USPC:345/173Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched
USPC:345/173

Electronic data base consulted during the international search (name of data base and, where practicable, search terms used)

Electronic Database Searched: PubWEST(PGPB, USPT, EPAB, JPAB), Google Scholar

Search Terms Used: touch, capacitive, sensor, pad, screen, sensitive, display, touchscreen, touchpad, capacitive, capacitance, conductive, controller, microcontroller, card, adapter, driver, sense, detect, reader, row, horizontal, x, axis, two second, multiple, pluralit

C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
Y	US 2009/0267903 A1 (CADY et al.) 29 October 2009 (29.10.2009), see entire document; especially Abstract; para [0016]-[0021], [0026], Figs. 1, 2, 5	1-26
Y	US 2009/0066669 A1 (OLSON) 12 March 2009 (12.03.2009), see entire document; especially Abstract; para [0019]-[0023], [0025]-[0030], [0039], [0049], [0052]; Figs. 2, 3, 5A-5C	1-26
A	US 2009/0002338 A1 (KINOSHITA et al.) 01 January 2009 (01.01.2009), see entire document	1-26
A	US 2008/0278178 A1 (PHILIPP) 13 November 2008 (13.11.2008), see entire document	1-26
A	US 2008/0158183 A1 (HOTELLING et al.) 03 July 2008 (03.07.2008), see entire document	1-26
A	US 2008/0142352 A1 (WRIGHT) 19 June 2008 (19.06.2008), see entire document	1-26
A	US 2008/0007534 A1 (PENG et al.) 10 January 2008 (10.01.2008), see entire document	1-26
A	US 2008/0036473 A1 (JANSSON) 14 February 2008 (14.02.2008), see entire document	1-26

 Further documents are listed in the continuation of Box C.

* Special categories of cited documents:	
"A"	document defining the general state of the art which is not considered to be of particular relevance
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"O"	document referring to an oral disclosure, use, exhibition or other means
"P"	document published prior to the international filing date but later than the priority date claimed
"T"	later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention
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"Y"	document of particular relevance; the claimed invention cannot be considered to involve an inventive step when the document is combined with one or more other such documents, such combination being obvious to a person skilled in the art
"&"	document member of the same patent family

Date of the actual completion of the international search	Date of mailing of the international search report
24 January 2011 (24.01.2011)	17 FEB 2011
Name and mailing address of the ISA/US Mail Stop PCT, Attn: ISA/US, Commissioner for Patents P.O. Box 1450, Alexandria, Virginia 22313-1450 Facsimile No. 571-273-3201	Authorized officer: Lee W. Young PCT Helpdesk: 571-272-4300 PCT OSP: 571-272-7774